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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) Yamamoto, et al.  
Serial No.: 09/600,931  
Confirmation No.: Unassigned  
Filed: July 21, 2000  
For: DAMASCENE  
INTERCONNECTION AND  
SEMICONDUCTOR  
DEVICE

Examiner: Eugene Lee  
Group Art Unit: 2815  
Docket: 362-43 PCT/US/RCE  
Dated: June 7, 2002

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20231 on June 7, 2002

Dated: 6/7/02 Melinda Kerrige

REPLY TO FINAL OFFICE ACTION

Sir:

In response to the final Office Action mailed October 9, 2001 and the Advisory Action mailed April 5, 2002, please amend the above-identified application as follows. A Request for Continued Examination is being submitted herewith.

IN THE CLAIMS:

Please amend Claims 1 and 8 by rewriting the same as follows:

1. (Twice Amended) A damascene interconnection comprising:  
an interconnection trench formed in an insulating film and a pad trench  
communicating therewith;

*Done  
cont'd  
subj*